

Please cancel claim 46.

42. (Previously Presented) An electronic device having a substrate fabricated according to a process that includes forming on said substrate inside a deposition chamber an amorphous silicon-based film having a tensile stress of between about 10<sup>8</sup> and about 10<sup>9</sup> dyne/cm<sup>2</sup>, the method comprising:

introducing a silicon-based volatile into the deposition chamber;

introducing into the deposition chamber a conductivity-increasing volatile including one or more components for increasing the conductivity of the amorphous silicon-based film; and

introducing into the deposition chamber a conductivity-decreasing volatile including two or more components for decreasing the conductivity of the amorphous silicon-based film; wherein the conductivity-increasing and conductivity-decreasing volatile are introduced into said deposition chamber at a flow rate ratio between about 1:1 and about 1:1000 conductivity-increasing to conductivity-decreasing volatile; thereby forming said amorphous silicon-based film on said substrate.

- 43. (Previously Presented) The electronic device of claim 42, wherein said deposition chamber is a CVD chamber or a PECVD chamber.
- 44. (Previously Presented) The electronic device of claim 42, wherein the flow rate ratio is selected to achieve a film resistivity of about 10<sup>3</sup>-10<sup>7</sup> ohm-cm.
- 45. (Previously Presented) The electronic device of claim 42, wherein the conductivity-increasing volatile consists of phosphine and the conductivity-decreasing volatile consists of ammonia and methane, and the flow rate ratio is in a range of about 1:1000 to about 1:10.
- 46. (Canceled)

- 47. (Previously Presented) The electronic device of claim 42, wherein the conductivity-increasing volatile includes an n-type dopant or a p-type dopant.
- 48. (Previously Presented) The electronic device of claim 42, wherein the amorphous silicon-based film is characterized by a band gap, and the conductivity-decreasing volatile includes a band gap increasing component that increases the band gap of the amorphous silicon-based film relative to a film formed under similar conditions but without the band gap increasing component.
- 49. (Previously Presented) The electronic device of claim 42, wherein the conductivity-decreasing volatile includes nitrogen or carbon.
- 50. (Previously Presented) The electronic device of claim 42, wherein the silicon-based film consists of silane, the conductivity-increasing volatile consists of phosphine, and the conductivity-decreasing volatile consists of ammonia and methane.
- 109. (Previously Presented) The electronic device of claim 42, wherein said electronic device is a field emission device.
- 110. (Previously Presented) The electronic device of claim 42, wherein said electronic device is a flat panel display device.